

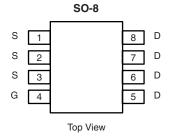
RoHS

COMPLIANT

Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
30	0.0079 at V _{GS} = 10 V	19.3 ^a	8.8 nC			
	0.010 at V _{GS} = 4.5 V	17.1 ^a	0.0110			



TrenchFET[®] Power MOSFET

100 % R_g Tested
100 % UIS Tested

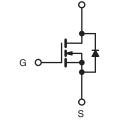
• Halogen-free

APPLICATIONS

- DC/DC
 - High Side
 - VRM



- Server



Ordering Information: Si4162DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		19.3 ^a		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		15.4		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	13.6 ^{b, c}	•	
	T _A = 70 °C		10.9 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	70		
Avalanche Current		I _{AS}	31		
Avalanche Energy	L = 0.1 mH		48	mJ	
Oraclin David David Divide Oracad	T _C = 25 °C	E _{AS}	4.2 ^a	^	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.1 ^{b, c}	A	
	T _C = 25 °C		5		
Maximum Power Dissipation	T _C = 70 °C		3.2	w	
	T _A = 25 °C	P _D	2.5 ^{b, c}	vv	
	T _A = 70 °C		1.6 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	<u></u>	
Soldering Recommendations (Peak Temperature)			260		

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	≤ 10 s R _{thJA} 38 50		°C/W			
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	20	25	0/11		

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 85 $^{\circ}\text{C/W}.$

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Si4162DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					1 1		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 uA		32		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	- μΑ	
		V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			А	
	Р	V _{GS} = 10 V, I _D = 20 A		0.0065	0.0079	- Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 14 A		0.0082	0.010		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		70		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1155			
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		260		pF	
Reverse Transfer Capacitance	C _{rss}			95			
Total Gate Charge		V _{DS} = 15 V, V _{GS} = 10 V, I _D = 20 A		20	30	nC	
	Qg			8.8	14		
Gate-Source Charge	Q _{gs}	V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 20 A		3.5			
Gate-Drain Charge	Q _{gd}			2.2			
Gate Resistance	R _g	f = 1 MHz		1.0	2.0	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		15	25	- ns	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 1.0 A, V_GEN = 4.5 V, R_g = 17 Ω		25	40		
Fall Time	t _f			10	15		
Turn-On Delay Time	t _{d(on)}			14	20		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		9	15		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.0$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω		25	40		
Fall Time	t _f			9	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			30	٨	
Pulse Diode Forward Current	I _{SM}				70	A	
Body Diode Voltage	V _{SD}	$I_{\rm S} = 4.0 \text{ A}, V_{\rm GS} = 0 \text{ V}$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			21	42	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			15	30	nC	
Reverse Recovery Fall Time	t _a	$I_F = 4.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		12.6			
Reverse Recovery Rise Time	t _b	-		8.4		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

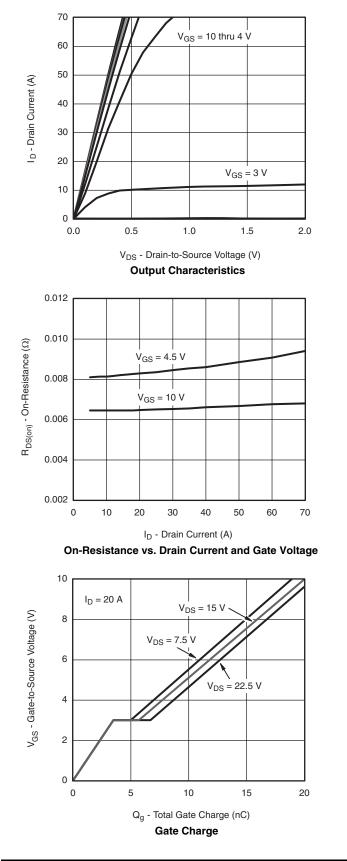
b. Guaranteed by design, not subject to production testing.

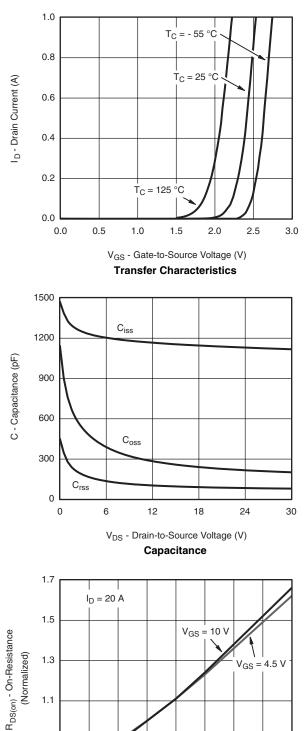
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Si4162DY Vishay Siliconix

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





0.9

0.7

- 50

- 25

0

25

50

T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

75

100

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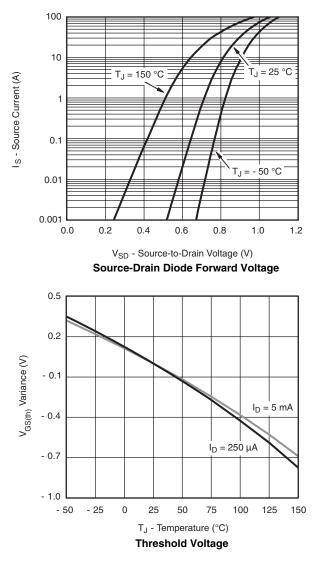
150

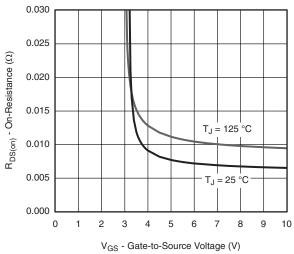
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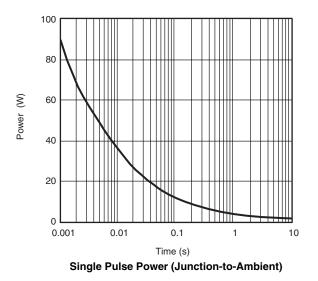


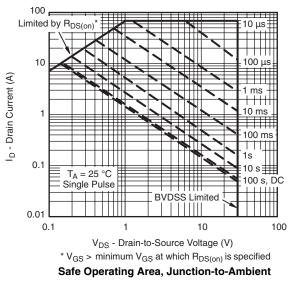
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





On-Resistance vs. Gate-to-Source Voltage

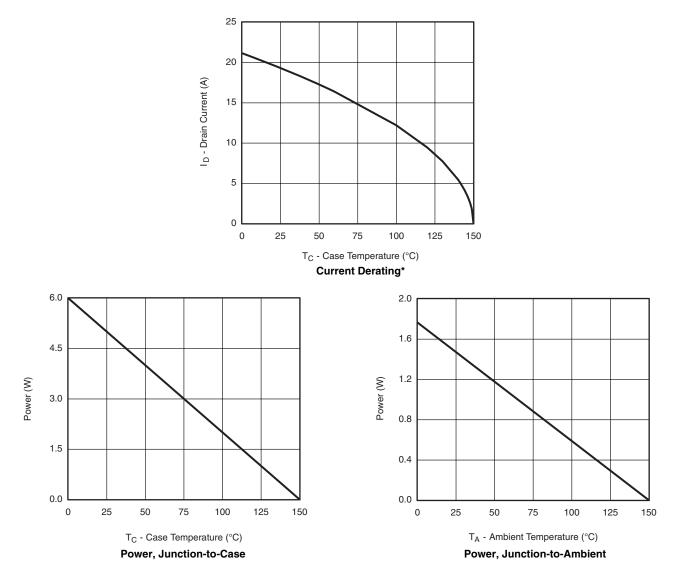




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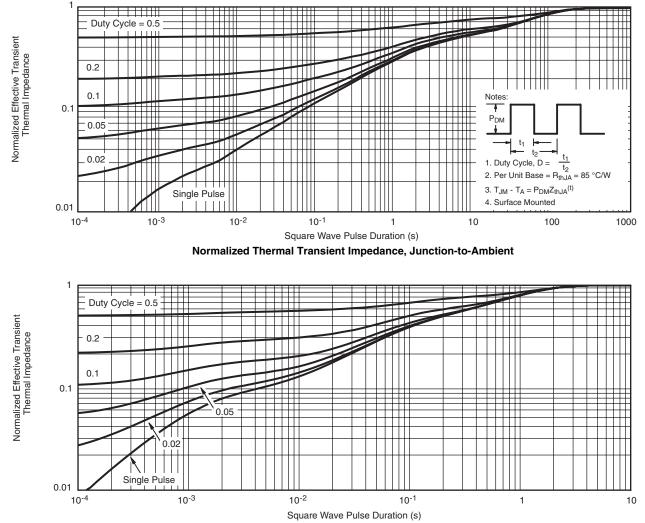
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68967.

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